

#### Description

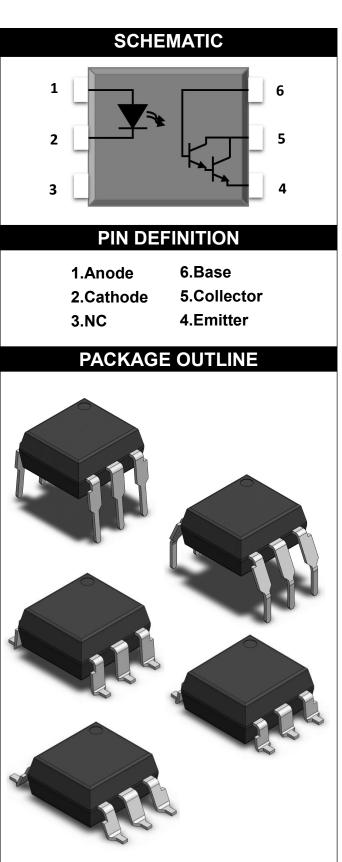
The 4N29, 4N30, 4N31, 4N32, 4N33 H11B1, H11B2, H11B3, H11B255 series combine an AlGaAs infrared emitting diode as the emitter which is optically coupled to a silicon planar darlington phototransistor detector in a plastic DIP6 package with different lead forming options

#### Features

- High isolation 5000 VRMS
- DC input with transistor output
- Operating temperature range 55 °C to 110 °C
- RoHS & REACH Compliance
- MSL class 1
- Regulatory Approvals
  - UL UL1577
  - VDE EN60747-5-5(VDE0884-5)
  - CQC GB4943.1, GB8898
  - cUL- CSA Component Acceptance
    Service Notice No. 5A

#### Applications

- Low power logic circuits
- Telecommunications equipment
- Portable electronics
- Interfacing coupling systems of different potentials and impedances





PARAMETER	SYMBOL	VALUE	UNIT	NOTE
I	NPUT			-
Forward Current	IF	60	mA	
Peak Forward Current(t=10µs)	I <sub>FM</sub>	1	A	1
Reverse Voltage	VR	6	V	
Power Dissipation(TA=25°C)	PD	120	mW	
0	UTPUT			
Collector - Emitter Voltage	V <sub>CEO</sub>	55	V	
Collector-Base Breakdown Voltage	V <sub>CBO</sub>	55	V	
Emitter - Collector Voltage	V <sub>ECO</sub>	7	V	
Emitter-Base Breakdown Voltage	VEBO	7	V	
Collector Current	lc	150	mA	
Power Dissipation(TA=25°C)	Pc	150	mW	
CC	DMMON			
Total Power Dissipation	Ptot	200	mW	
Isolation Voltage	Viso	5000	Vrms	2
Operating Temperature	Topr	-55~+110	°C	
Storage Temperature	Tstg	-55~+110	°C	
Soldering Temperature	Tsol	260	°C	

Note 1. AC For 1 Minute, R.H. = 40 ~ 60% Note 2. For 10 seconds



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DIP6, DC Input, Photo Transistor Coupler

ELECTRICAL OPTICAL CHARACTERISTICS at Ta=25°C								
PARAMETER	SYMBOL		MIN	TYP.	MAX	UNIT	TEST CONDITION	NOTE
INPUT								
	VF	/	-	1.24	1.4	V	IF=10mA	
Forward Voltage	VI	H11B3	-	1.4	1.5	V	IF=50mA	
Reverse Current	I <sub>R</sub>		-	-	10	μA	VR=6V	
Input Capacitance	Cin		-	50	-	pF	V=0, f=1kHz	
				Ουτρι	JT			
Collector Dark Current	I <sub>CEO</sub>		-	-	100	nA	VCE=10V	
Collector-Emitter Breakdown Voltage	BV <sub>CEO</sub>		55	-	-	V	IC=0.1mA	
Collector-Base Breakdown Voltage	Breakdown BV <sub>CBO</sub>		55	-	-	V	IC=0.1mA	
Emitter-Collector Breakdown Voltage	Breakdown BV <sub>ECO</sub>		7	-	-	V	IE=0.1mA	

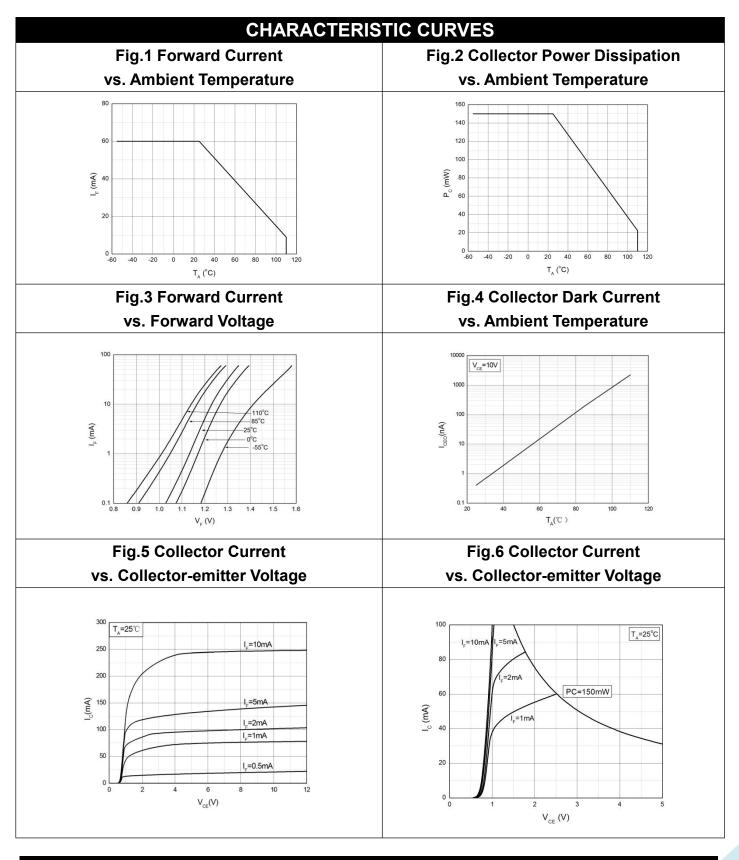


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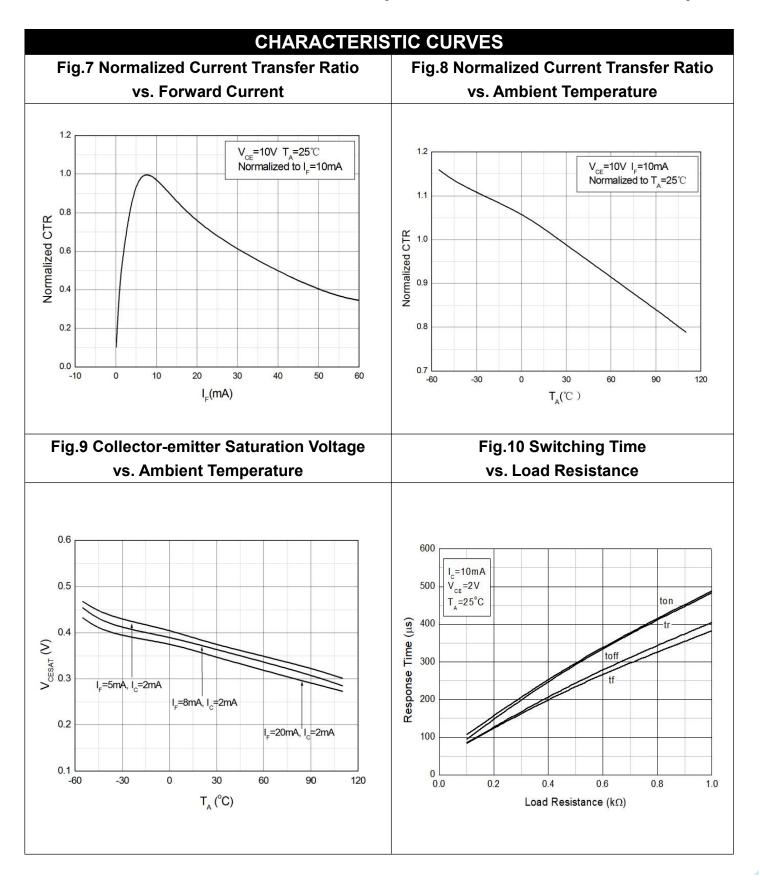
		TRANS	SFER C	HARA	CTER	ISTICS	6
	CTR	4N31	50	-	-		
Current		4N29,4N30	100	-	-		IF=10mA, VCE=10V
		4N32,4N33	500	-	-		
Transfer		H11B1	500	-	-	%	
Ratio		H11B2	200	-	-		IF=1mA, VCE=5V
		H11B3	100	-	-		
		H11B255	100	-	-		IF=10mA, VCE=5V
	V	4N29,4N30, 4N32,4N33	-	-	1.0	V	IF= 8mA, IC= 2mA
Collector-Emitt er		4N31	-	-	1.2		IF= 8mA, IC= 2mA
Saturation Voltage		H11B1,H11B2 H11B3	-	-	1.0		IF= 1mA, IC= 1mA
		H11B255	-	-	1.0		IF= 50mA, IC= 50mA
Isolation Resistance	Rio		10^11	-	-	Ω	Vio=500Vdc.
Floating Capacitance	CIO		-	0.8	-	pF	V=0, f=1MHz
Turn On Time	t <sub>on</sub>	H11B1,H11B2 H11B3, H11B255	-	25	-	μs	IC= 10mA, VCC= 2V, RL= 100Ω
Tum On Time		4N29,4N30, 4N31,4N32 4N33	-	-	5	μs	IC= 10mA, VCC= 2V, RL= 100Ω
	t <sub>off</sub>	H11B1,H11B2 H11B3, H11B255	-	18	-	μs	IC= 10mA, VCC= 2V, RL= 100Ω
Turn Off Time		4N32,4N33	-	-	100	μs	IC= 10mA, VCC= 2V,
		4N29,4N30, 4N31	-	-	40	μs	RL= 100Ω



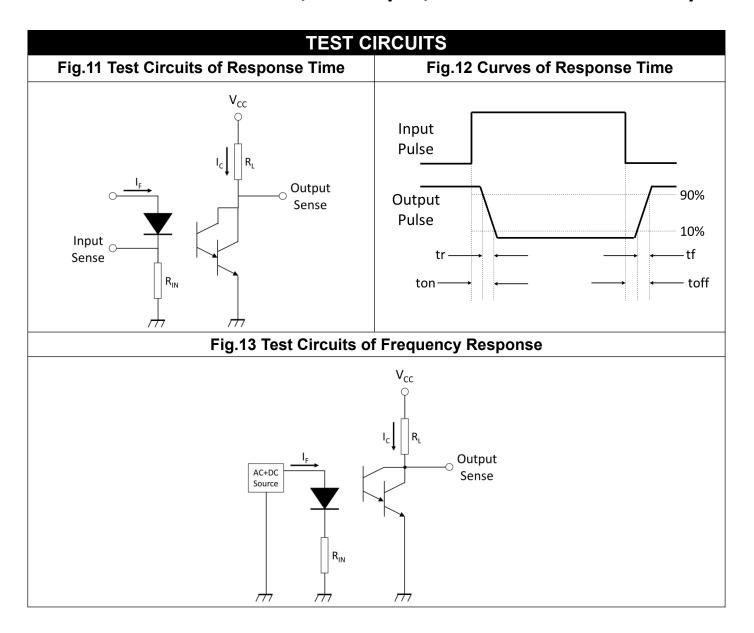


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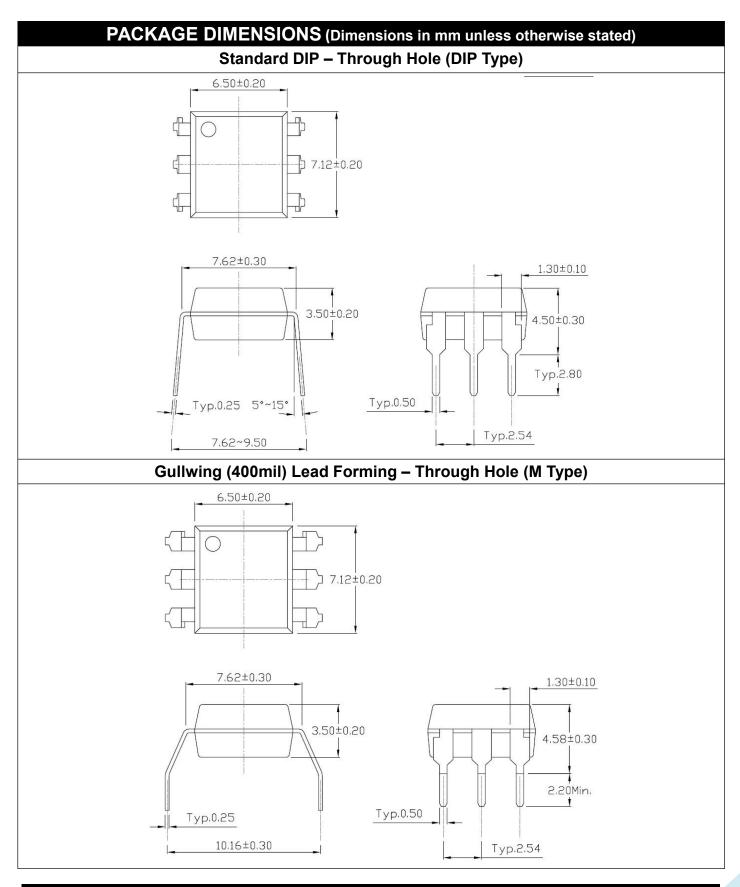




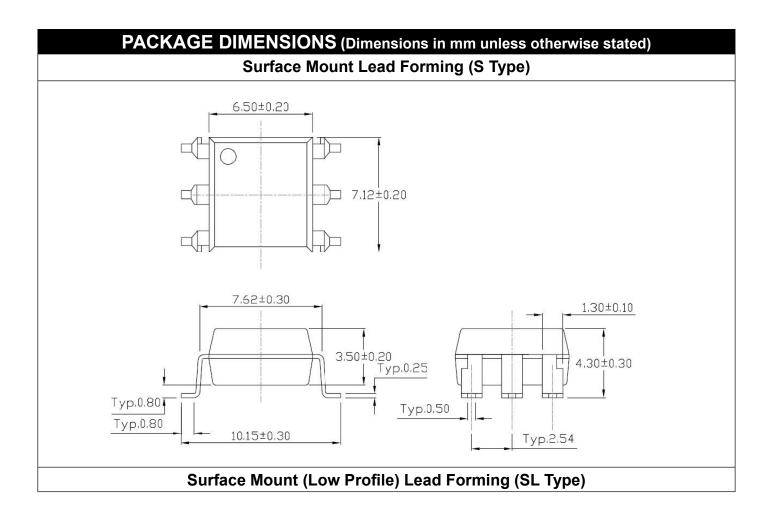








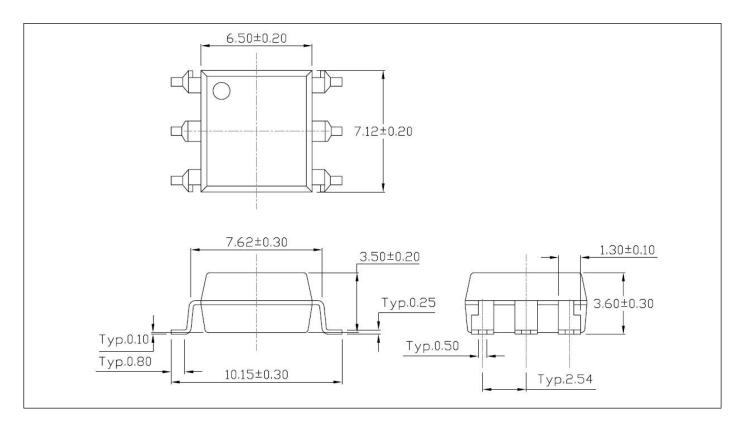


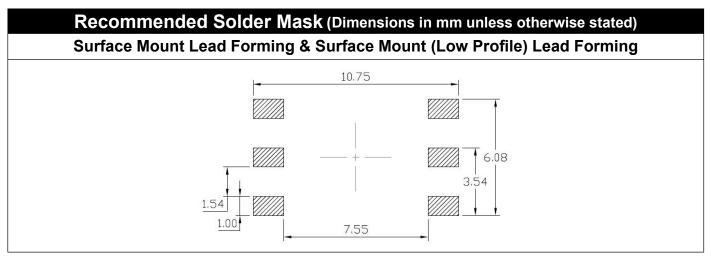




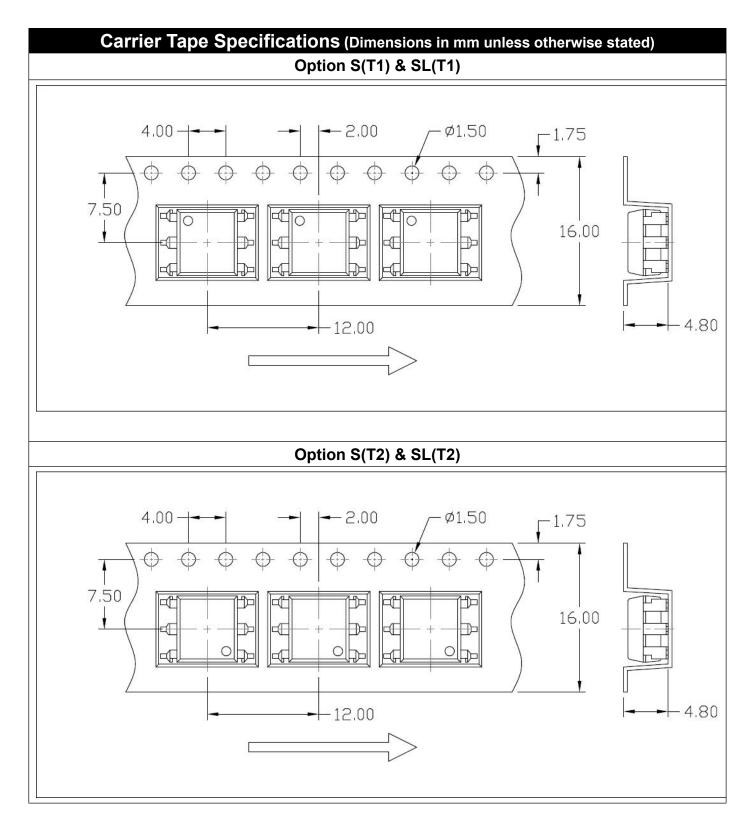
## 4N29, 4N30, 4N31, 4N32, 4N33, H11B1,H11B2,H11B3,H11B255

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ORDERING AND MARKIN	MARKING INFO	RMATION
TD		Company Abbr.
4NXX	V : V	Part Number & Rank /DE Option Fiscal Year
VYAWW		Manufacturing Code Work Week
ORDERING INFORMATION	LA	ABEL INFORMATION



# 4NXX(Y)(Z)-GV

# H11BX(Y)(Z)-GV

TD – Company Abbr.

4NXX/ – Part Number and Rank (XX=29/30/31/32/33)

H11BX/ – Part Number and Rank

(X=1/2/3/255)

Y – Lead Form Option

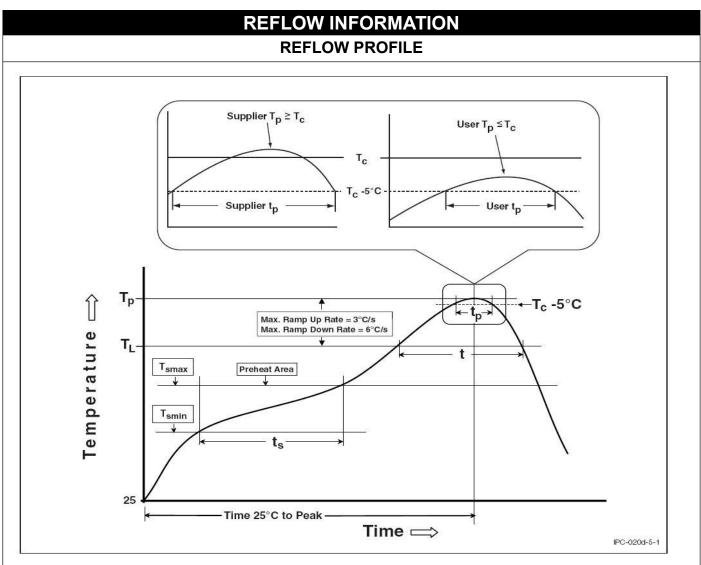
(M/S/SL/SLM/None)

- Z Tape and Reel Option (T1/T2)
- G Material Option
- (G: Green, None: Non-Green)
- V VDE Option (V or None)



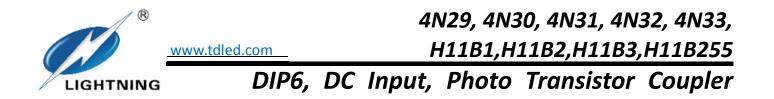
PACKING QUANTITY					
Option	Description	Quantity			
None	Standard 6 Pin Dip	50Units/Tube			
М	Gullwing(400mil) Lead Forming	50Units/Tube			
S(T1)	Surface Mount Lead Forming – With Option 1 Taping	1000 Units/Reel			
S(T2)	Surface Mount Lead Forming – With Option 2 Taping	1000 Units/Reel			
SL(T1)	Surface Mount Lead Forming(Low Profile) – With Option 1 Taping	1000 Units/Reel			
SL(T2)	Surface Mount Lead Forming(Low Profile) – With Option 2 Taping	1000 Units/Reel			



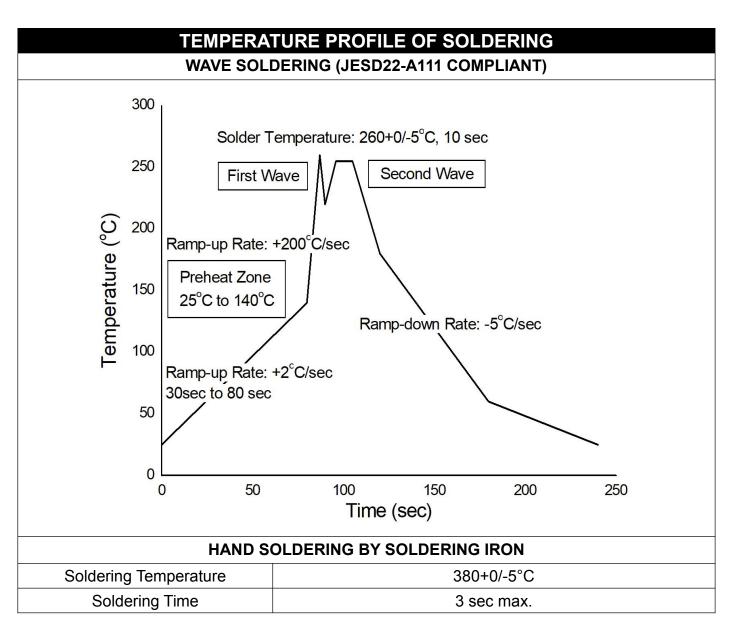


Profile Feature	Sn-Pb Assembly Profile	Pb-Free Assembly Profile	
Temperature Min. (Tsmin)	100	150°C	
Temperature Max. (Tsmax)	150	200°C	
Time (ts) from (Tsmin to Tsmax)	60-120 seconds	60-120 seconds	
Ramp-up Rate (tL to tP)	3°C/second max.	3°C/second max.	
Liquidous Temperature (TL)	183°C	217°C	
Time (tL) Maintained Above (TL)	60 – 150 seconds	60 – 150 seconds	
Peak Body Package Temperature	235°C +0°C / -5°C	260°C +0°C / -5°C	
Time (tP) within 5°C of 260°C	20 seconds	30 seconds	
Ramp-down Rate (TP to TL)	6°C/second max	6°C/second max	
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.	

Document No: Preliminary







- One time soldering is recommended for all soldering method.
- Do not solder more than three times for IR reflow soldering.



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